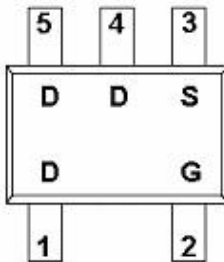
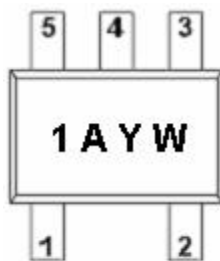


DESCRIPTION

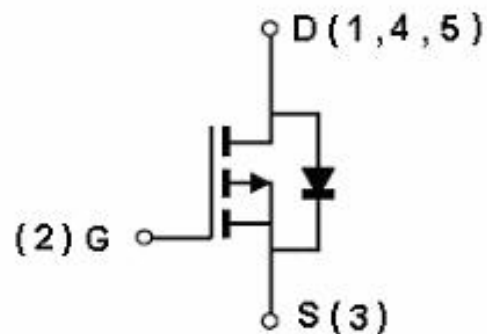
The STP1413A is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer circuits where high-side switching, low in-line power loss are needed in a very small outline surface mount package

**PIN CONFIGURATION
SOT-353/SC70**

FEATURE

- -20V/-3.4A, $R_{DS(ON)} = 130\text{m-ohm}@V_{GS} = -4.5\text{V}$
- -20V/-2.4A, $R_{DS(ON)} = 150\text{m-ohm}@V_{GS} = -2.5\text{V}$
- -20V/-1.7A, $R_{DS(ON)} = 190\text{m-ohm}@V_{GS} = -1.8\text{V}$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional low on-resistance and maximum DC current capability
- SOT-353 / SC70 package design

PART MARKING


Y : Year Code
W : Week Code





STP1413A



P_ Channel Enhancement Mode MOSFET
-3.4A

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-20	V
Gate-Source Voltage	V _{GSS}	+/-12	V
Continuous Drain Current (T _J =150°C)	I _D	T _A =25°C	-2.3
		T _A =70°C	-1.7
Pulsed Drain Current	I _{DM}	-6	A
Continuous Source Current (Diode Conduction)	I _S	-1.4	A
Power Dissipation	P _D	T _A =25°C	0.95
		T _A =70°C	0.51
Operation Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	105	°C/W



STP1413A

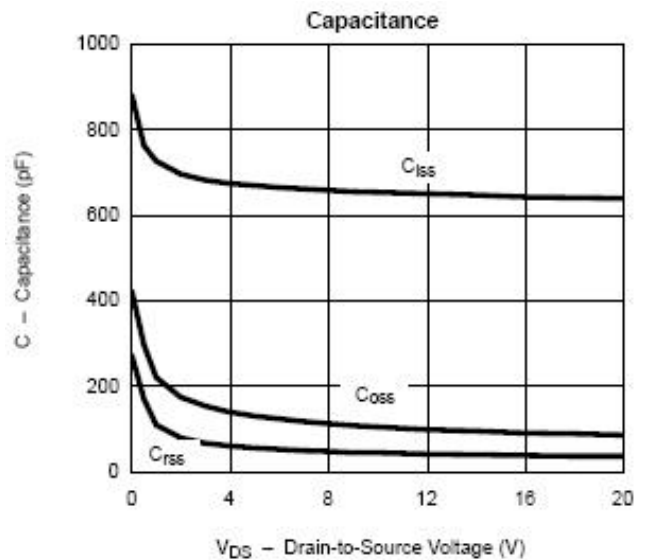
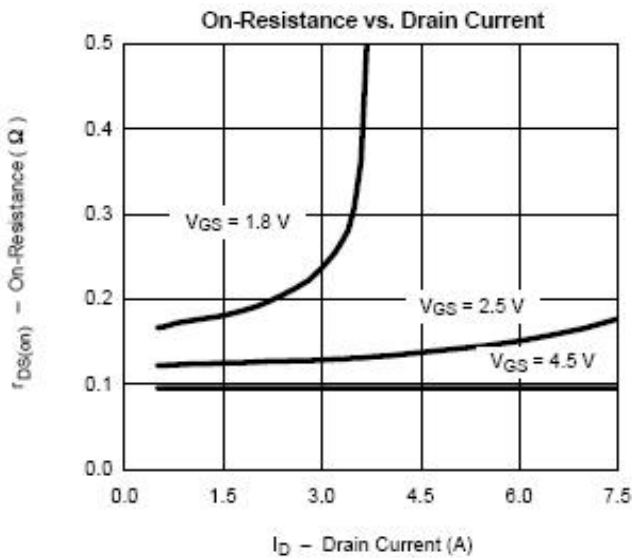
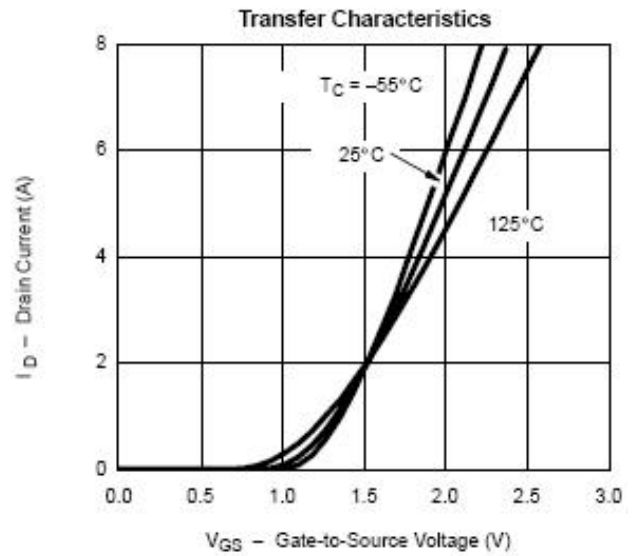
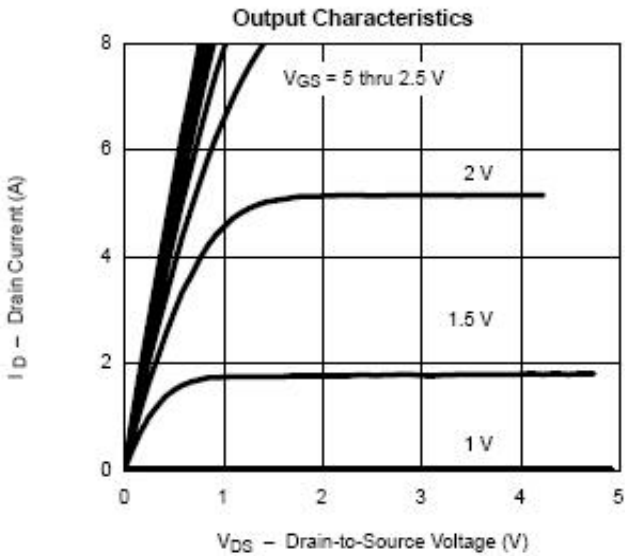


P_ Channel Enhancement Mode MOSFET
-3.4A

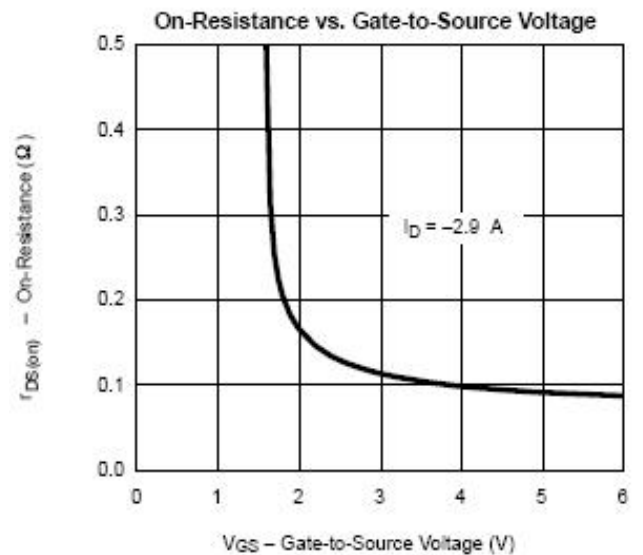
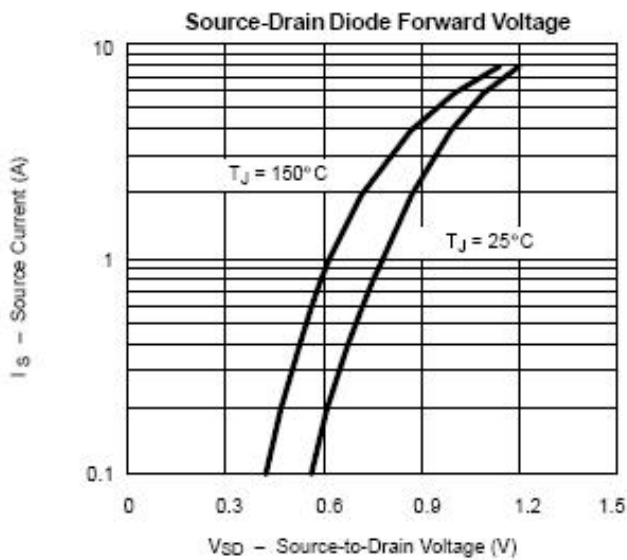
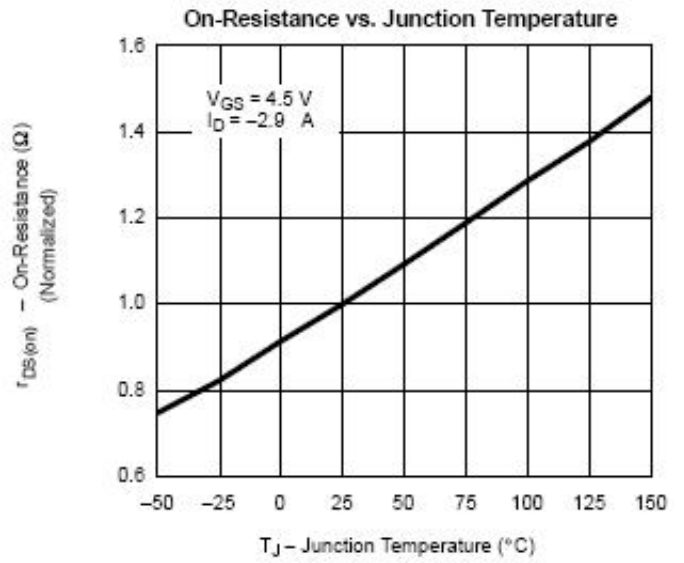
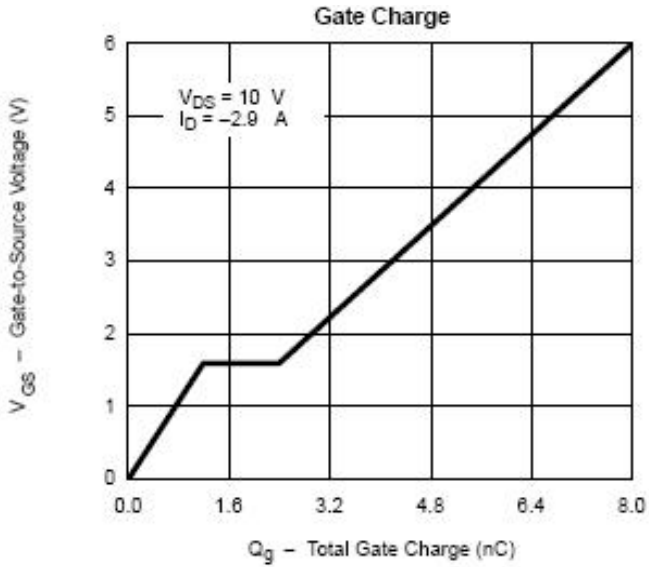
ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.35		-0.8	V
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=+/-12V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-20V, V_{GS}=0V$			-1	uA
		$V_{DS}=-20V, V_{GS}=0V$ $T_J=55^\circ C$			-5	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \leq -5V, V_{GS}=-4.5V$	-6			A
Drain-source On-Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-3.4A$		110	130	mΩ
		$V_{GS}=-2.5V, I_D=-2.4A$		130	150	
		$V_{GS}=-1.8V, I_D=-1.7A$		170	190	
Forward Transconductance	g_{fs}	$V_{DS}=-5V, I_D=-2.8A$		6		S
Diode Forward Voltage	V_{SD}	$I_S=-1.5A, V_{GS}=0V$		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=-6V, V_{GS}=-4.5V,$ $V_{DS}=-2.8A$		4.8	8	nC
Gate-Source Charge	Q_{gs}			1.0		
Gate-Drain Charge	Q_{gd}			1.0		
Input Capacitance	C_{iss}	$V_{DS}=-6V, V_{GS}=0V$ $f=1MHz$		485		pF
Output Capacitance	C_{oss}			85		
Reverse Transfer Capacitance	C_{rss}			40		
Turn-On Time	$T_{d(on)}$	$V_{DD}=-6V, R_L=6\Omega, I_D=-1.0A,$ $V_{GEN}=-4.5V, R_G=6\Omega$		10	16	nS
	t_r			13	23	
Turn-Off Time	$T_{d(off)}$			18	25	
	t_f			15	20	

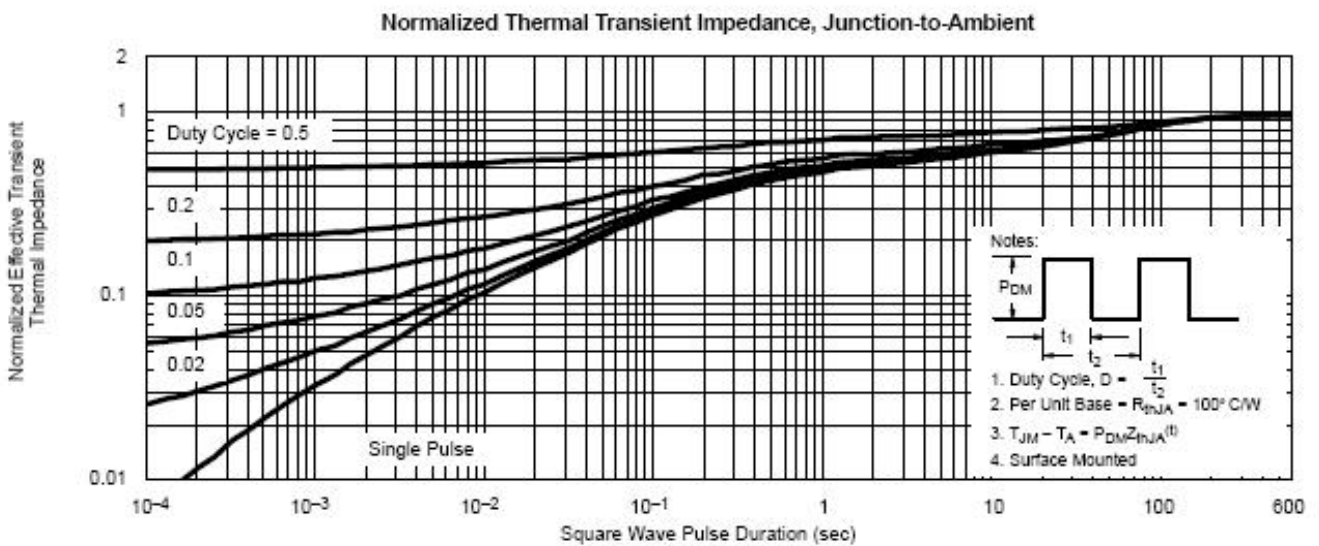
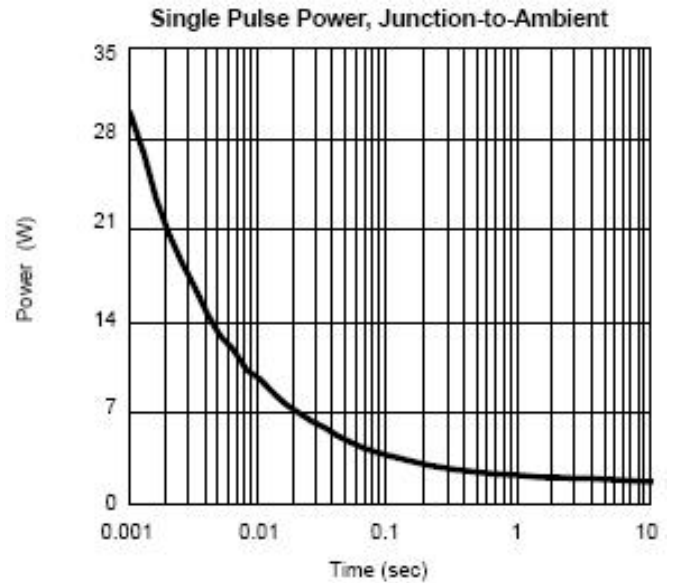
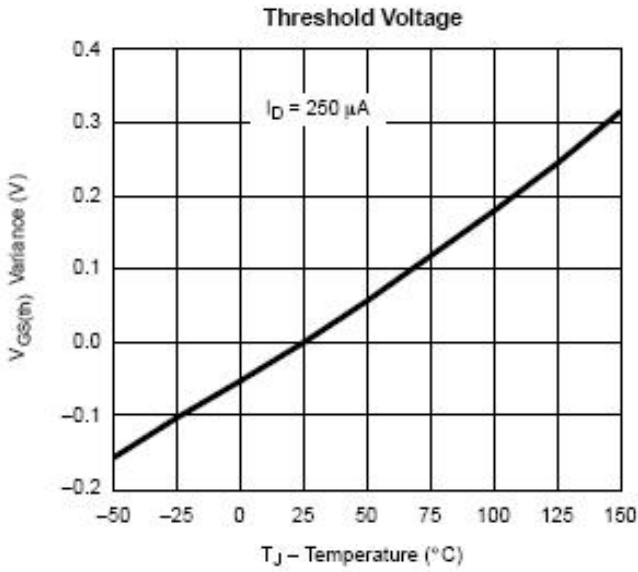
TYPICAL CHARACTERISTICS

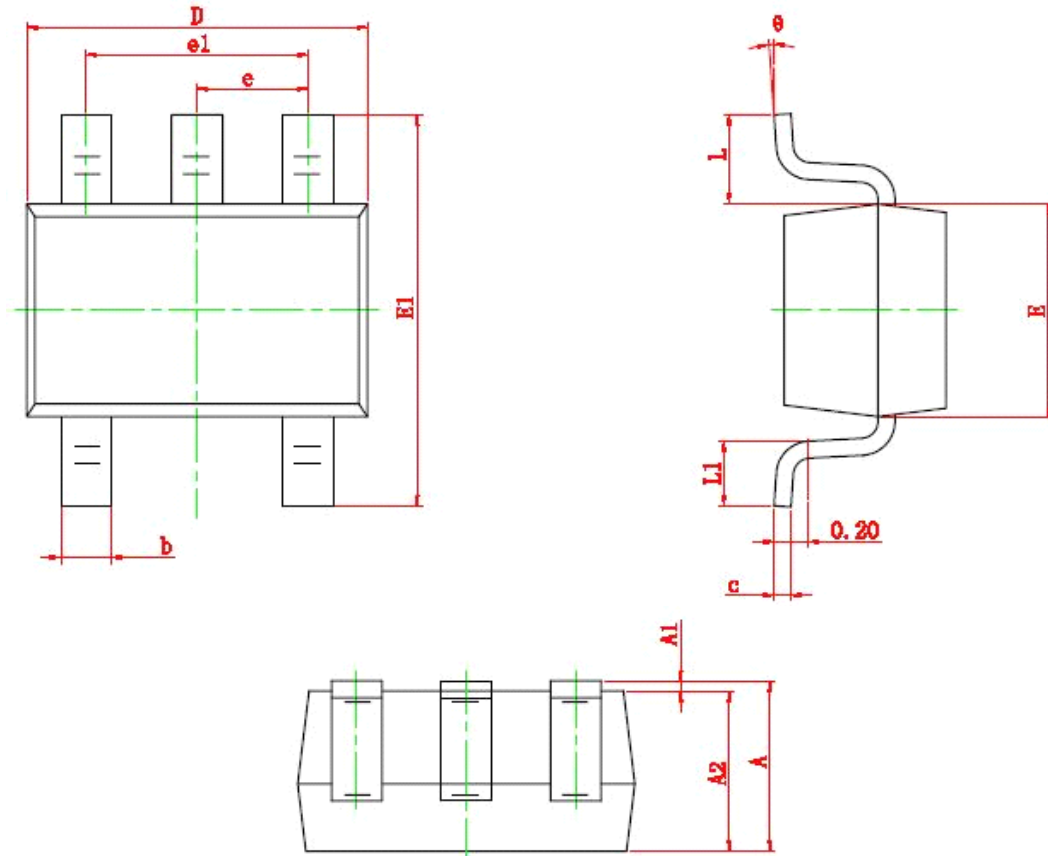


TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



SOT353 (sc70-6L) PACKAGE OUTLINE


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
theta	0°	8°	0°	8°